

4 and 8-Channel EMI Filter Arrays with ESD Protection

CM1406

Features

- Four and eight channels of EMI filtering with ESD protection
- Greater than 30dB of attenuation from 800MHz to 3GHz
- 15kV ESD protection (IEC 61000-4-2, contact discharge)
- 30kV ESD protection (HBM)
- Fabricated with Centurion[™] advanced low capacitance zener process technology
- Space saving, low-profile 8 and 16-lead TDFN packages
- Lead-free and RoHS compliant

Applications

- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- EMI filtering for LCD, camera and chip-to-chip data lines

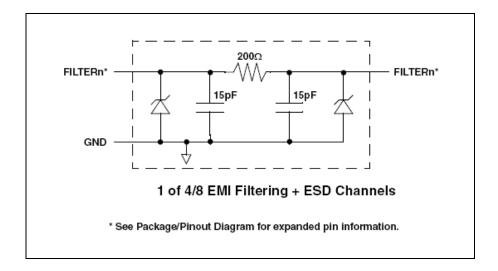
Product Description

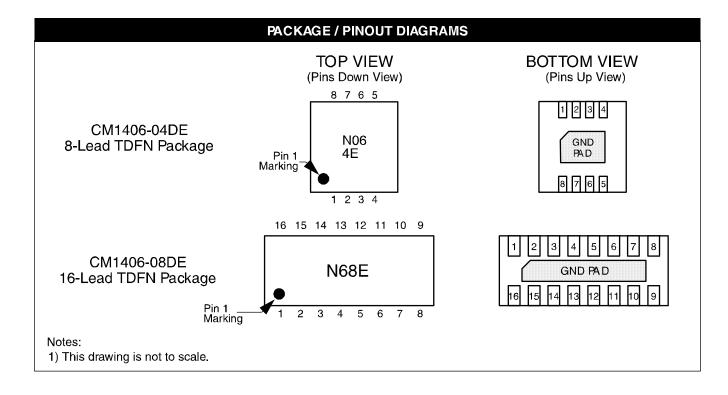
The CM1406 is an EMI filter array with ESD protection, which integrates either four or eight pi filters (C-R-C). Each CM1406 filter has component values of 15pF-200W-15pF. These parts include ESD protection diodes on every pin, providing a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports safely dissipate ESD strikes of •15kV contact discharge, twice the specification requirement of the IEC 61000-4-2, Level 4 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than •30kV.

This device is particularly well suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy-to-use pin assignments. In particular, the CM1406 is ideal for EMI filtering and protecting data lines from ESD in wireless handsets.

The CM1406 is available in space-saving, low-profile, 8-lead and 16-lead TDFN packages. It is fabricated with *Centurion*™ process and available with lead-free finishing.

Block Diagram





PIN DESCRIPTIONS									
Pins				Pins					
1406- 04Dx	1406- 08Dx	NAME	DESCRIPTION	1406- 04Dx	1406- 08Dx	NAME	DESCRIPTION		
1	1	FILTER1	Filter Channel 1	8	16	FILTER1	Filter Channel 1		
2	2	FILTER2	Filter Channel 2	7	15	FILTER2	Filter Channel 2		
3	3	FILTER3	Filter Channel 3	6	14	FILTER3	Filter Channel 3		
4	4	FILTER4	Filter Channel 4	5	13	FILTER4	Filter Channel 4		
	5	FILTER5	Filter Channel 5		12	FILTER5	Filter Channel 5		
	6	FILTER6	Filter Channel 6		11	FILTER6	Filter Channel 6		
	7	FILTER7	Filter Channel 7		10	FILTER7	Filter Channel 7		
	8	FILTER8	Filter Channel 8		9	FILTER8	Filter Channel 8		
GND) Pad	GND	Device Ground						

Ordering Information

PART NUMBERING INFORMATION							
		Lead-free Finish					
Leads/Pins	Package	Ordering Part Number ¹	Part Marking				
8	TDFN-08	CM1406-04DE	N06 4E				
16	TDFN-16EEP	CM1406-08DE	N68E				

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

Specifications

ABSOLUTE MAXIMUM RATINGS							
PARAMETER RATING UI							
Storage Temperature Range	-65 to +150	°C					
DC Power per Resistor	100	mW					
Package DC Power Rating	300	mW					

STANDARD OPERATING CONDITIONS							
PARAMETER	RATING	UNITS					
Operating Temperature Range	-40 to +85	°C					

ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1)									
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS			
R	Resistance		160	200	240	Ω			
С	Capacitance	At 2.5V DC, 1MHz, 30mV AC	12	15	18	pF			
V _{DIODE}	Diode Standoff Voltage	$I_{\text{DIODE}} = 10 \mu A$		6.0		V			
I _{LEAK}	Diode Leakage Current (reverse bias)	V _{DIODE} = 3.3V		0.1	1	μА			
V _{SIG}	Signal Voltage Positive Clamp Negative Clamp	$I_{LOAD} = 10$ mA $I_{LOAD} = -10$ mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V V			
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	Note 2	30 15			kV kV			
f _c	Cut-off Frequency $Z_{\text{SOURCE}} = 50\Omega$, $Z_{\text{LOAD}} = 50\Omega$	R = 200Ω, C = 15pF;		105		MHz			

Note 1: $T_A=25$ °C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Performance Information

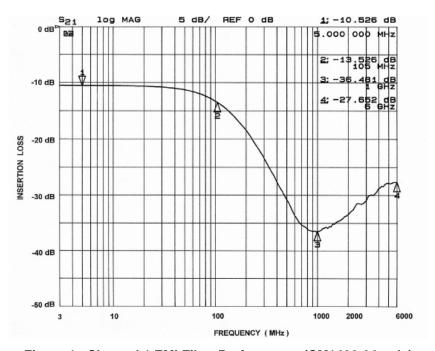


Figure 1. Channel 1 EMI Filter Performance (CM1406-04 only)

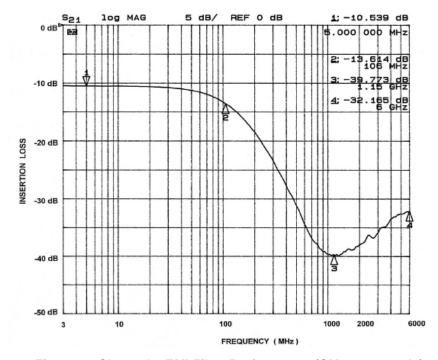


Figure 2. Channel 2 EMI Filter Performance (CM1406-04 only)

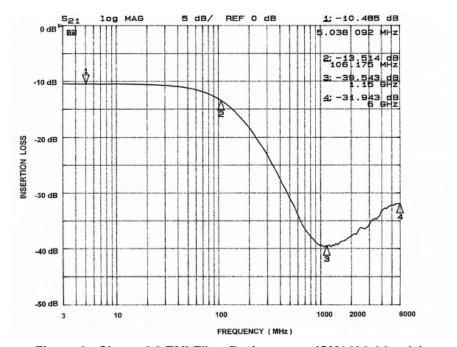


Figure 3. Channel 3 EMI Filter Performance (CM1406-04 only)

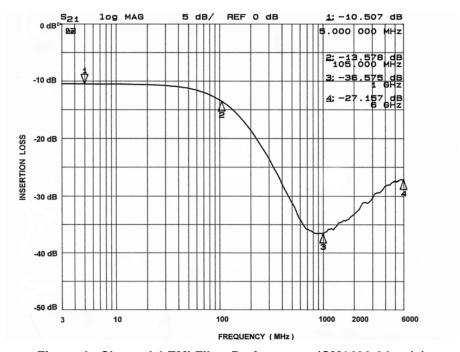


Figure 4. Channel 4 EMI Filter Performance (CM1406-04 only)

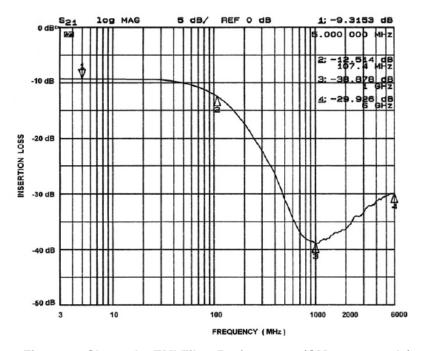


Figure 5. Channel 1 EMI Filter Performance (CM1406-08 only)

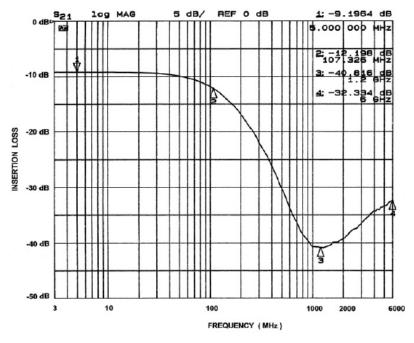


Figure 6. Channel 2 EMI Filter Performance (CM1406-08 only)

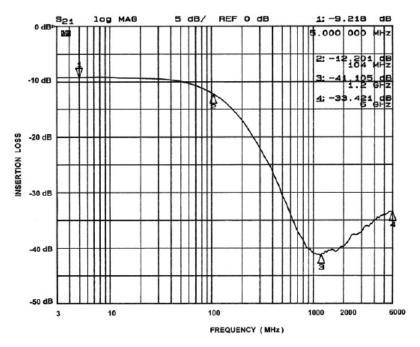


Figure 7. Channel 3 EMI Filter Performance (CM1406-08 only)

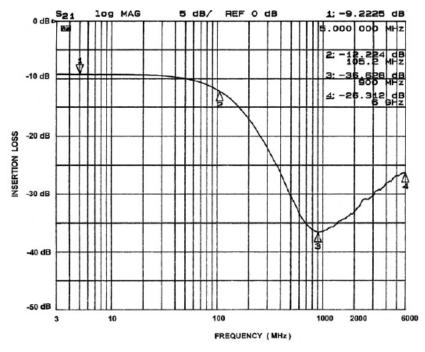


Figure 8. Channel 4 EMI Filter Performance (CM1406-08 only)

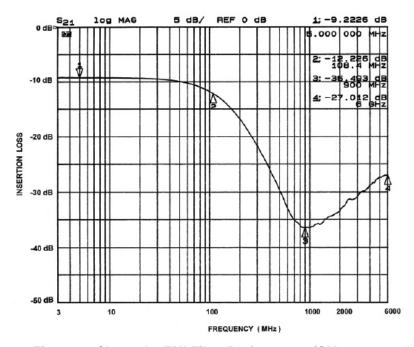


Figure 9. Channel 5 EMI Filter Performance (CM1406-08 only)

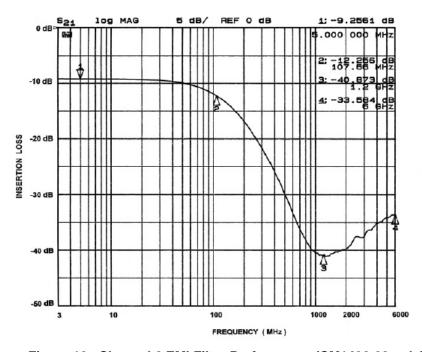


Figure 10. Channel 6 EMI Filter Performance (CM1406-08 only)

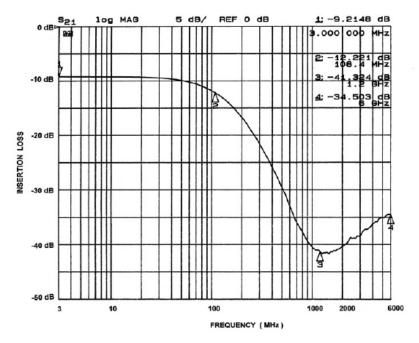


Figure 11. Channel 7 EMI Filter Performance (CM1406-08 only)

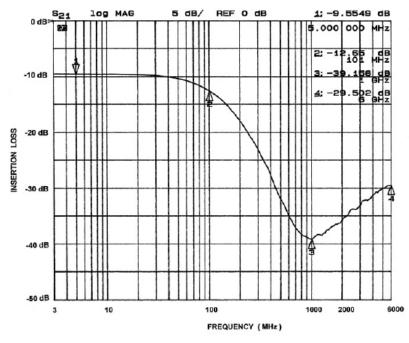


Figure 12. Channel 8 EMI Filter Performance (CM1406-08 only)

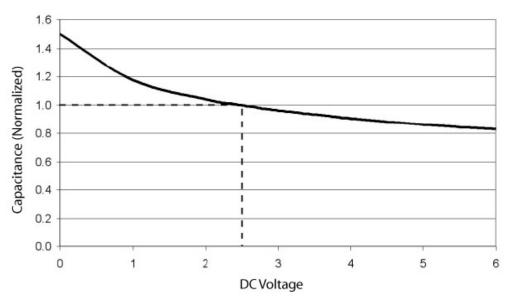


Figure 13. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5VDC and 25°C)

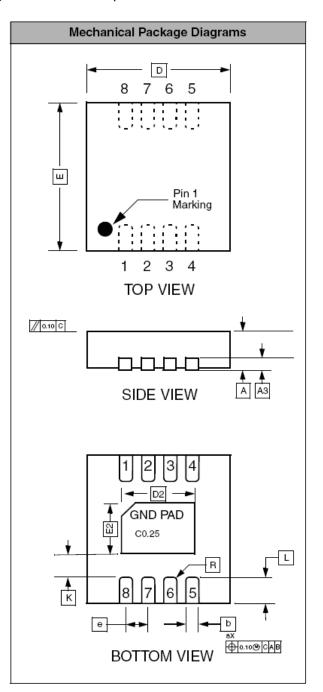
Mechanical Details

TDFN-08 Mechanical Specifications, 0.5mm

The CM1406 is supplied in an 8-lead 0.5mm TDFN package. Dimensions are presented below.

	PAC	KAGE	DIME	NSIO	NS		
Package	TDFN						
JEDEC No.	MO-229 (Var. VCCD-3)*						
Leads				8			
Dim.	Millimeters			Inches			
D	Min	Nom	Max	Min	Nom	Max	
A	0.70	0.75	0.80	0.028	0.030	0.031	
А3	0.20 REF 0.008 REF				F		
b	0.20	0.25	0.30	0.008	0.010	0.012	
D	1.90	2.00	2.10	0.075	0.079	0.083	
D2	1.50	1.60	1.70	0.059	0.063	0.067	
E	1.90	2.00	2.10	0.075	0.079	0.083	
E2	0.80	0.90	1.00	0.031	0.035	0.039	
е	0.50 BSC 0.020 BSC					C	
К	0.20			0.008			
L	0.20	0.30	0.40	0.008	0.012	0.016	
# per 3000 pieces tape and reel							
Controlling dimension: millimeters							

This package is compliant with JEDEC standard MO-229, variation VCCD-3 with exception of the D2 and E2 dimensions as called out in the table above and the r1 dimension which is not specified in the MO-229 standard.



Dimensions for 8-Lead, 0.5mm pitch TDFN package

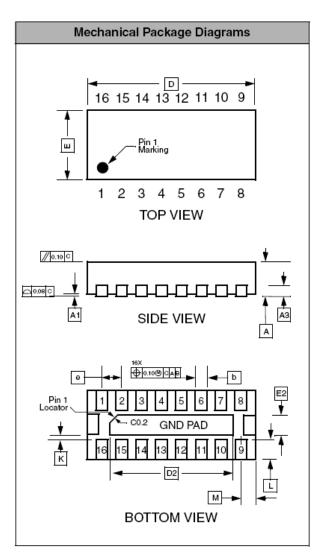
Mechanical Details (Cont'd)

TDFN-16EEP Mechanical Specifications, 0.5mm

The CM1406 is supplied in a 16-lead, 0.5mm pitch TDFN package with Exposed End Pads (EEP). Dimension are presented below.

PACKAGE DIMENSIONS								
Package	Package TDFN							
JEDEC No.	MO-229C*							
Leads			1	16				
Dim.	Millimeters			Inches				
Dilli.	Min	Nom	Max	Min	Nom	Max		
Α	0.70	0.75	0.80	0.028	0.030	0.031		
A1	0.00	0.02	0.05	0.000 0.001 0.00				
А3	(0.20 REF 0.008 REF				F		
b	0.20	0.25	0.30	0.008 0.010 0.01				
D	3.90	4.00	4.10	0.153 0.157 0.		0.161		
D2	3.10	3.20	3.30	0.122 0.126 0.13		0.130		
E	1.50	1.60	1.70	0.059 0.063 0.0		0.067		
E2	0.30	0.40	0.50	0.012	0.016	0.020		
е	(0.50 BS	С	C	.020 BS	Ö		
к	0.20			0.008				
L	0.20	0.30	0.40	0.008	0.010	0.012		
М	0.25 REF 0.010 REF					F		
# per tape and reel	3000 pieces							
	Controlling dimension: millimeters							

This package is compliant with JEDEC standard MO-229C with the exception of the D, D2, E, E2, K and L dimensions as called out in the table above.



Dimensions for 16-Lead, 0.5mm pitch TDFN package with Exposed End Pads (EEP)

CM1406

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